



## CyberOptics Receives \$1.2 Million Order for 3D MX3000™ Systems

CyberOptics will release its operating results for the first quarter of 2021 on April 27<sup>th</sup>

Minneapolis, MN—April 6, 2021 —CyberOptics Corporation (Nasdaq: CYBE), a leading global developer and manufacturer of high precision sensing technology solutions, today announced that it recently received an order valued at \$1.2 million for its MX3000 memory module inspection systems, powered by Multi-Reflection Suppression™ (MRS™) sensors. These final vision inspection (FVI) systems are expected to be recognized as revenue in the second half of 2021.

CyberOptics will release its operating results for the first quarter of 2021 on April 27<sup>th</sup> after market close.

### About CyberOptics

CyberOptics Corporation ([www.cyberoptics.com](http://www.cyberoptics.com)) is a leading global developer and manufacturer of high-precision 3D sensing technology solutions. CyberOptics' sensors are used for inspection and metrology in the SMT and semiconductor markets to significantly improve yields and productivity. By leveraging its leading edge technologies, the Company has strategically established itself as a global leader in high precision 3D sensors, allowing CyberOptics to further increase its penetration of key vertical markets. Headquartered in Minneapolis, Minnesota, CyberOptics conducts worldwide operations through its facilities in North America, Asia and Europe.

Statements regarding the Company's anticipated performance are forward-looking and therefore involve risks and uncertainties, including but not limited to: a possible world-wide recession or depression resulting from the economic consequences of the COVID-19 pandemic; the negative effect on our revenue and operating results of the COVID-19 crisis on our customers and suppliers and the global supply chain; market conditions in the global SMT and semiconductor capital equipment industries; trade relations between the United States and China and other countries; the timing of orders and shipments of our products, particularly our 3D MRS™ SQ3000 Multi-Function systems™ and MX systems for memory module inspection; increasing price competition and price pressure on our product sales, particularly our SMT systems; the level of orders from our OEM customers; the availability of parts required to meet customer orders; unanticipated product development challenges; the effect of world events on our sales, the majority of which are from foreign customers; rapid changes in technology in the electronics and semiconductor markets; product introductions and pricing by our competitors; the success of our 3D technology initiatives; the market acceptance of our SQ3000 Multi-Function™ inspection and measurement systems and products for semiconductor advanced packaging inspection and metrology; costly and time consuming litigation with third parties related to intellectual property infringement; the negative impact on our customers and suppliers due to past and future terrorist threats and attacks and any acts of war; the impact of the MX3000™ orders on our consolidated gross margin percentage in any future period; risks related to cancellation or renegotiation of orders we have received; and other factors set forth in the Company's filings with the Securities and Exchange Commission.

# # #

### For additional information, contact:

Jeffrey A. Bertelsen, Chief Financial Officer  
763-542-5000

Carla Furanna, Vice President of Global Marketing  
952-820-5837